General-purpose MOS FET Relays in SOP 4-pin packages for a wide range of applications

• Load voltage: 80 V

RoHS Compliant



Note: The actual product is marked differently from the image shown here.

■Application Examples

- · Semiconductor test equipment
- Test & Measurement equipment
- Communication equipment
- Security equipment
- Industrial equipment Power circuit
- · Amusement equipment

■Package (Unit:mm, Average)

SOP 4-pin



Note: The actual product is marked differently from the image shown here.

■Model Number Legend

G3VM-1 2 3 4

1. Load Voltage 2. Contact form 8: 80 V

3. Package 1: 1a (SPST-NO) G: SOP 4-pin

4. Other informations

When specifications overlap, serial code is added in the recorded order.

■Ordering Information

	Contact form	Terminals	Load voltage (peak value) *	Continuous load current (peak value) *	Stick packaging		Tape packaging	
Package					Model	Minimum package quantity	Model	Minimum package quantity
SOP4	1a (SPST-NO)	Surface-mounting Terminals	80 V	350 mA	G3VM-81G1	100 pcs.	G3VM-81G1(TR)	2,500 pcs.

* The AC peak and DC value are given for the load voltage and continuous load current.

Note: To order tape packaging for Relays with surface-mounting terminals, add "(TR)" to the end of the model number.

■Absolute Maximum Ratings (Ta = 25°C)

	Item	Symbol	G3VM-81G1	Unit	Measurement conditions	
Input	LED forward current	lF	50	mA		
	LED forward current reduction rate	ΔIF/°C	-0.5	mA/°C	Ta ≥ 25°C	
	LED reverse voltage	VR	5	V		
	Connection temperature	TJ	125	°C		
	Load voltage (AC peak/DC)	Voff	80	V		
Ħ	Continuous load current (AC peak/DC)	lo	350	mA		
utput	ON current reduction rate	Δlo/°C	-3.5	mA/°C	Ta ≥ 25°C	
0	Pulse ON current	lop	1.05	mA	t=100 ms, Duty=1/10	
	Connection temperature	TJ	125	°C		
Dielectric strength between I/O (See note 1.)		V _{I-O}	1500	Vrms	AC for 1 min	
Ambient operating temperature		Ta	-20 to +85	°C	Mish i-i ddi	
Ambient storage temperature		Tstg	-40 to +125	°C	With no icing or condensation	
So	Idering temperature	-	260	°C	10 s	

Note: 1. The dielectric strength between the input and output was checked by applying voltage between all pins as a group on the LED side and all pins as a group on the light-receiving side.

■Electrical Characteristics (Ta = 25°C)

	Item	Symbol		G3VM-81G1	Unit	Measurement conditions
	item	Syllibol			Ullit	weasurement conditions
		VF	Minimum	1.0	٧	I==10 mA
	LED forward voltage		Typical	1.15		
			Maximum	1.3		
Input	Reverse current	IR	Maximum	10	μА	V _R =5 V
트	Capacitance between terminals	Ст	Typical	15	pF	V=0, f=1 MHz
	Trigger LED forward current	ler	Typical	1	mA	Io=350 mA
		IFT	Maximum	4	IIIA	
	Release LED forward current	IFC	Minimum	0.2	mA	Ioff=10 μA
	Maximum resistance with output ON	Ron	Typical	1	Ω	IF=5 mA, Io=350 mA
			Maximum	1.2		
put	Current leakage when the relay is open	ILEAK	Typical	0.2	nA	Voff=30 V, Ta=50°C
Output			Maximum	1		
	Capacitance between terminals	Coff	Typical	30	pF	V=0, f=100 MHz
			Maximum	40		
Ca	Capacitance between I/O terminals		Typical	0.8	pF	f=1 MHz, Vs=0V
Ins	Insulation resistance between I/O terminals		Minimum	1000	MQ.	Vi-o=500 VDC, RoH≤60%
ten			Typical	108	IVISZ	
Turn-ON time		ton	Typical	0.3		IF=5 mA, RL=200 Ω,
Tu	Turn-ON time		Maximum	0.5	1	
т	Tum-OFF time		Typical	0.3	ms	VDD=20 V (See note 2.)
Tu			Maximum	0.5	1	

Note: 2. Turn-ON and Turn-OFF Times



■Recommended Operating Conditions

For usage with high reliability, Recommended Operation Conditions is a measure that takes into account the derating of Absolute Maximum Ratings and Electrical Characteristics.

Each item on this list is an independent condition, so it is not simultaneously satisfy several conditions.

Item	Symbol		G3VM-81G1	Unit	
Load voltage (AC peak/DC)	V _{DD}	Maximum	64	V	
Operating LED forward current	lF	Minimum	5		
Operating LED forward current	IF.	Maximum	30	mA	
Continuous load current (AC peak/DC)	lo	Maximum	350	1	
Ambient operating temperature	Ta	Minimum	-20	°C	
Ambient operating temperature	1a	Maximum	60		

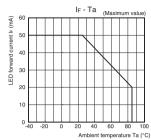
■Spacing and Insulation

Item	Minimum	Unit
Creepage distances	4.0	
Clearance distances	4.0	mm
Internal isolation thickness	0.1	

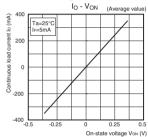
■Engineering Data

G3VM-81G

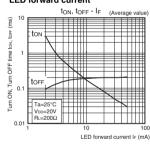
LED forward current vs. Ambient temperature



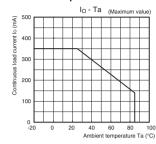
Continuous load current vs. On-state voltage



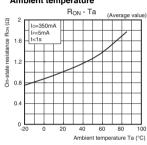
Turn ON, Turn OFF time vs. LED forward current



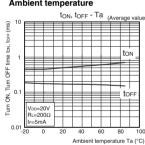
Continuous load current vs. Ambient temperature



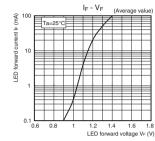
On-state resistance vs. Ambient temperature



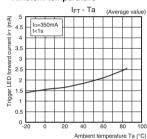
Turn ON, Turn OFF time vs. Ambient temperature



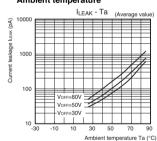
LED forward current vs. LED forward voltage



Trigger LED forward current vs. Ambient temperature



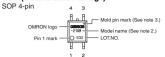
Current leakage vs. Ambient temperature



■Appearance / Terminal Arrangement / Internal Connections

Appearance

SOP (Small Outline Package)



Note: 1. The actual product is marked differently from the image shown here. Note: 2. "G3VM" does not appear in the model number on the Relay.

Note: 2. Grown does not appear in the moder number of the Nelay.

Note: 3. The indentation in the corner diagonally opposite from the pin 1 mark is from a pin on the mold.

Terminal Arrangement/Internal Connections (Top View)

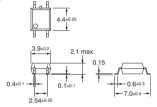


■Dimensions (Unit: mm)



Surface-mounting Terminals

Weight: 0.1 g



Actual Mounting Pad Dimensions

(Recommended Value, Top View)



Note: The actual product is marked differently from the image shown here.

■Approved Standards

UL recognized 💫

Approved Standards	Contact form	File No.
UL (recognized)	1a (SPST-NO)	E80555

■Safety Precautions

• Refer to the Common Precautions for All MOS FET Relays for precautions that apply to all MOS FET Relays.